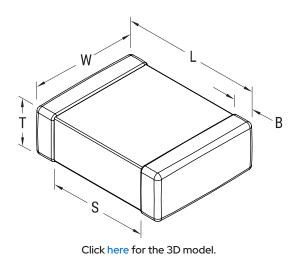


C1812X224J5GACTU

Aliases (C1812X224J5GAC7800) SMD Comm COG Flex, Ceramic, 0.22 uF, 5%, 50 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 1812, 2.3 mm



General Information	
Series	SMD Comm COG Flex
Style	SMD Chip
Description	SMD, MLCC, FT-CAP, Ultra- Stable
Features	FT-CAP, Ultra-Stable
RoHS	Yes
Termination	Flexible Termination
Marking	No
AEC-Q200	No
Typical Component Weight	87 mg
Shelf Life	78 Weeks
MSL	1

0.22 uF

Dimensions	
Chip Size	1812
L	4.5mm +/-0.4mm
W	3.2mm +/-0.3mm
Т	1.6mm +/-0.20mm
S	2.3mm MIN
В	0.7mm +/-0.35mm

L	4.5mm +/-0.4mm	Measurement Condition	1 kHz 1.0Vrms
W	3.2mm +/-0.3mm	Tolerance	5%
Т	1.6mm +/-0.20mm	Voltage DC	50 VDC
S	2.3mm MIN	Dielectric Withstanding Voltage	125 VDC
В	0.7mm +/-0.35mm	Temperature Range	-55/+125°C
		Temp. Coefficient	COG
Packaging Specifications		Capacitance Change with	30 ppm/C, 1kHz 1.0Vrms
Packaging	T&R, 180mm, Plastic Tape	Reference to +25°C and 0 VDC Applied (TCC)	, ,
Packaging Quantity 1000	1000	Dissipation Factor	0.1% 1 kHz 1.0Vrms
		Aging Rate	0% Loss/Decade Hour
		Insulation Resistance	4.5455 GOhms

Specifications

Capacitance

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